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Photocoupler
Product Data Sheet
LTV-817/ 827/ 847
(M, S, S-TA, S-TA1, S-TP)
Series

Spec No. :DS-70-96-0016

Effective Date: 08/09/2017

Revision: 0

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

Photocoupler LTV-8x7 Series

1. DESCRIPTION

1.1 Features

- Current transfer ratio (CTR : MIN. 50% at $I_F = 5\text{mA}$, $V_{CE} = 5\text{V}$)
- High input-output isolation voltage ($V_{iso} = 5,000\text{Vrms}$)
- Response time (t_r : TYP. $4\mu\text{s}$ at $V_{CE} = 2\text{V}$, $I_C = 2\text{mA}$, $R_L = 100\Omega$)
- Dual-in-line package :
 - LTV-817 : 1-channel type
 - LTV-827 : 2-channel type
 - LTV-847 : 4-channel type
- Wide lead spacing package :
 - LTV-817M : 1-channel type
 - LTV-827M : 2-channel type
 - LTV-847M : 4-channel type
- Surface mounting package :
 - LTV-817S : 1-channel type
 - LTV-827S : 2-channel type
 - LTV-847S : 4-channel type
- Tape and reel packaging :
 - LTV-817S-TA : 1-channel type
 - LTV-817S-TA1 : 1-channel type
 - LTV-817S-TP : 1-channel type
 - LTV-827S-TA : 2-channel type
 - LTV-827S-TA1 : 2-channel type
- Safety approval
 - UL 1577
 - VDE DIN EN60747-5-5 (VDE 0884-5)
 - CSA CA5A
 - CQC GB4943.1-2011/ GB8898-2011 (meet Altitude up to 5000m)
 - Nordic Safety (FIMKO/NEMKO/SEMKO/DEMKO)
 - BSI
- RoHS Compliance
 - All materials be used in device are followed EU RoHS directive (No. 2011/65/EU).
- ESD pass HBM 8000V/MM2000V
- MSL class1

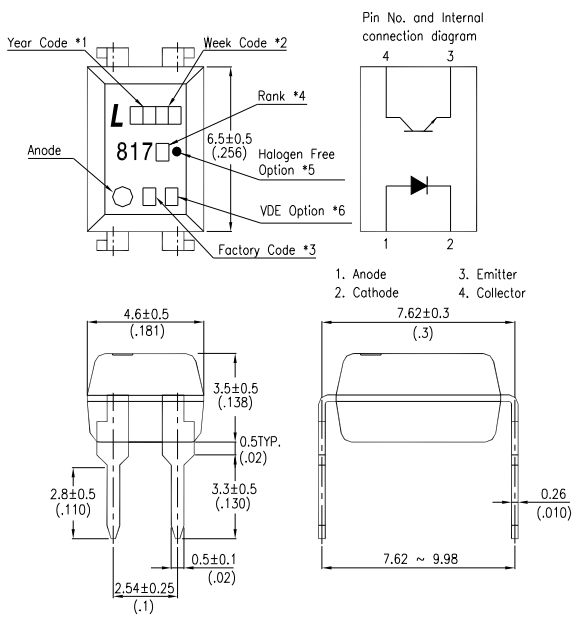
1.2 Applications

- Hybrid substrates that require high density mounting.
- Programmable controllers

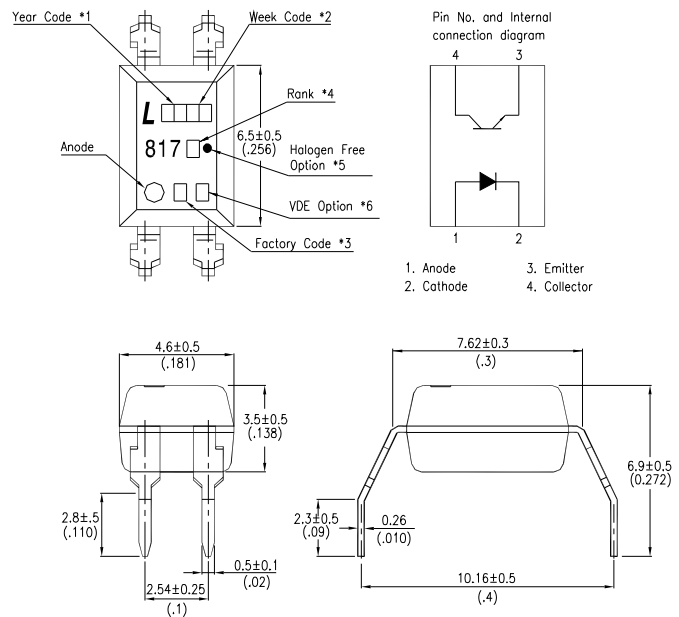
Photocoupler LTV-8x7 Series

2. PACKAGE DIMENSIONS

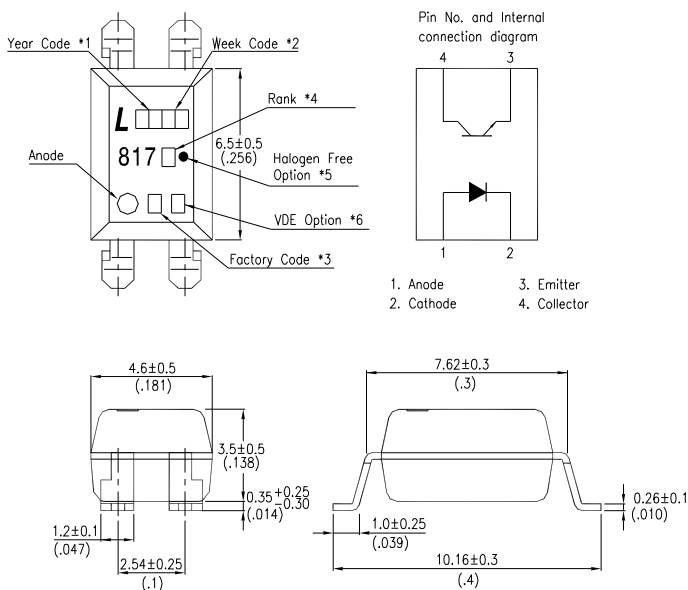
2.1 LTV-817



2.2 LTV-817M



2.3 LTV-817S



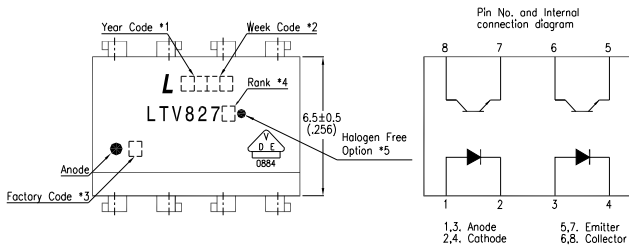
Notes :

1. 2-digit year code, example : 2016 = 16
2. 2-digit work week ranging from '01' to '53'
3. Factory identification mark shall be marked (W: China-CZ, Y: Thailand)
4. Rank shall be or shall not be marked.
5. "●" for halogen free option.
6. "4" or "V" for VDE option.

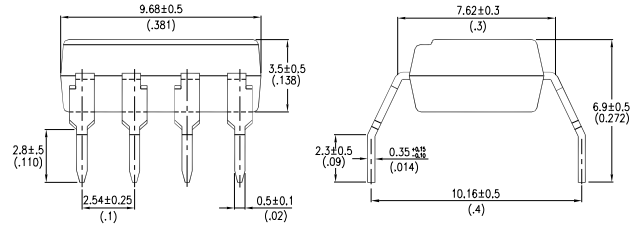
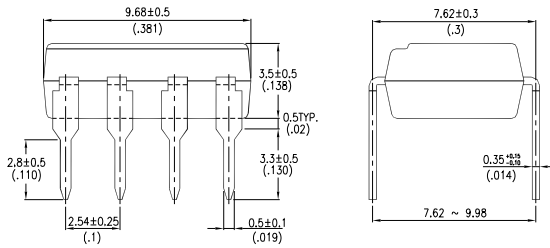
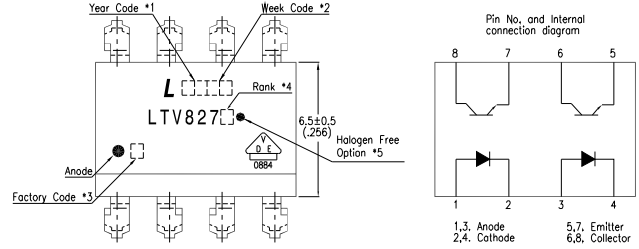
Dimensions in millimeters(inches).

Photocoupler LTV-8x7 Series

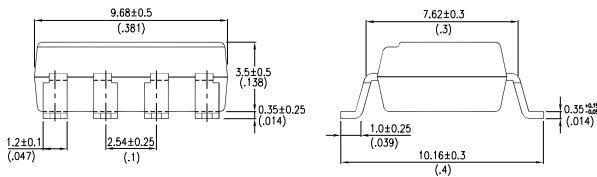
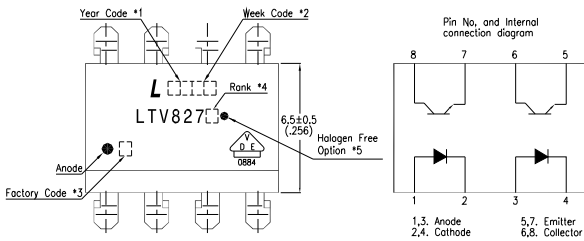
2.4 LTV-827



2.5 LTV-827M



2.6 LTV-827S



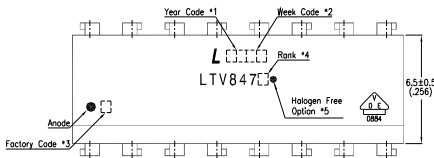
Notes :

1. 2-digit year code, example : 2016 = 16
2. 2-digit work week ranging from '01' to '53'
3. Factory identification mark shall be marked
(W: China-CZ, Y: Thailand)
4. Rank shall be or shall not be marked.
5. "●" for halogen free option.

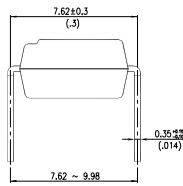
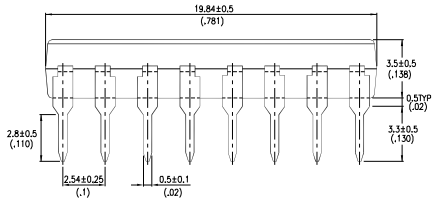
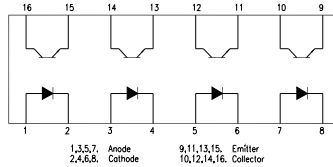
Dimensions in millimeters(inches).

Photocoupler LTV-8x7 Series

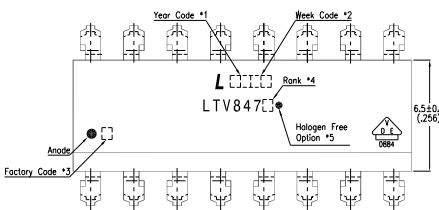
2.7 LTV-847



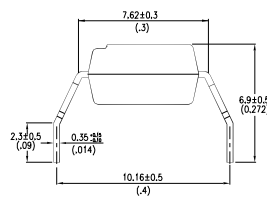
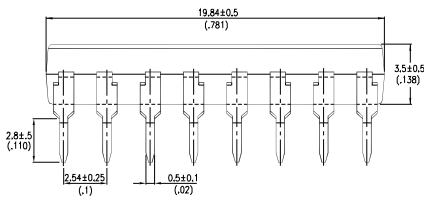
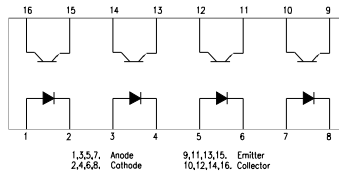
PIN NO. AND INTERNAL CONNECTION DIAGRAM



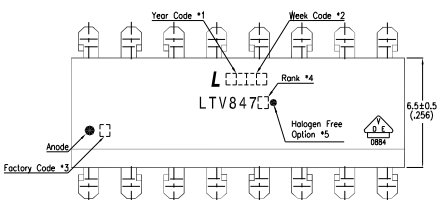
2.8 LTV-847M



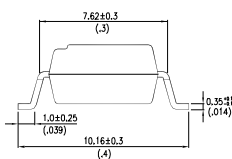
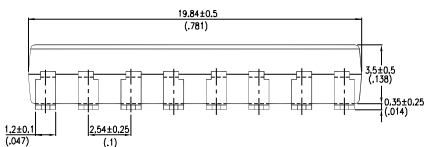
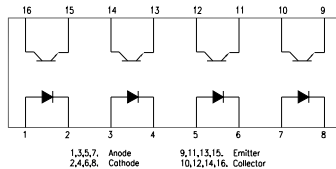
PIN NO. AND INTERNAL CONNECTION DIAGRAM



2.9 LTV-847S



PIN NO. AND INTERNAL CONNECTION DIAGRAM



Notes :

- 2-digit year code, example : 2016 = 16
- 2-digit work week ranging from '01' to '53'
- Factory identification mark shall be marked (W: China-CZ, Y: Thailand)
- Rank shall be or shall not be marked.
- for halogen free option.

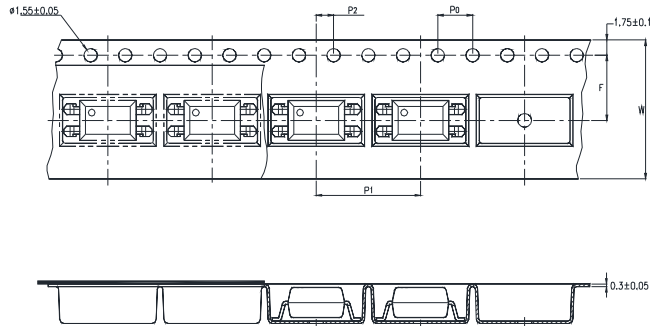
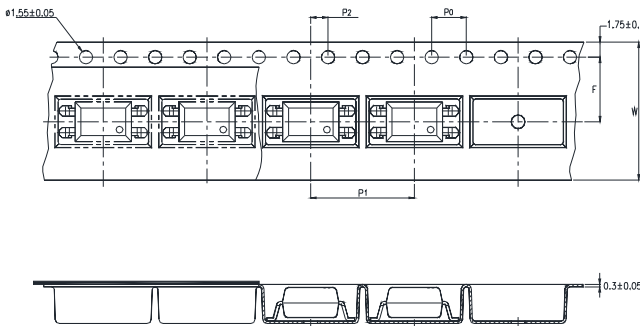
Dimensions in millimeters(inches).

Photocoupler LTV-8x7 Series

3. TAPING DIMENSIONS

3.1 LTV-817S-TA

3.2 LTV-817S-TA1



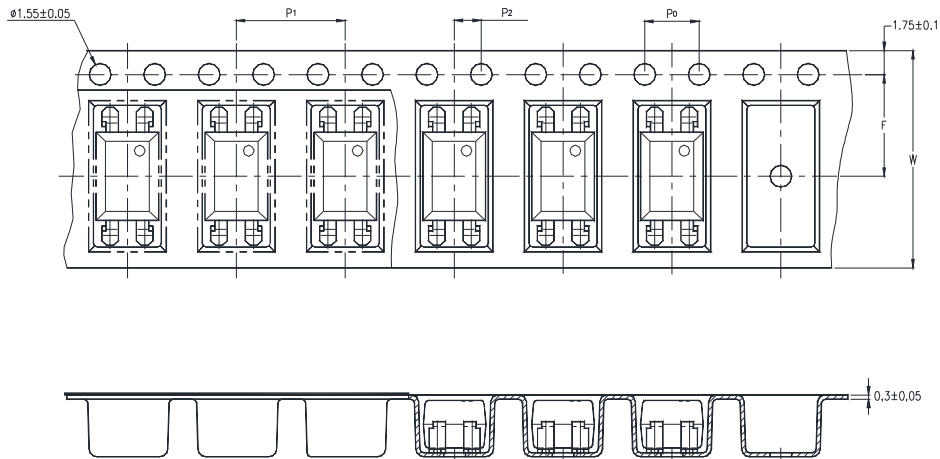
| Description | Symbol | Dimension in mm (inch) |
|--|----------------|------------------------|
| Tape wide | W | 16±0.3 (0.63) |
| Pitch of sprocket holes | P ₀ | 4±0.1 (0.15) |
| Distance of compartment | F | 7.5±0.1 (0.295) |
| | P ₂ | 2±0.1 (0.079) |
| Distance of compartment to compartment | P ₁ | 12±0.1 (0.472) |

3.3 Quantities Per Reel

| Package Type | TA/TA1 |
|------------------|--------|
| Quantities (pcs) | 1000 |

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3.4 LTV-817S-TP



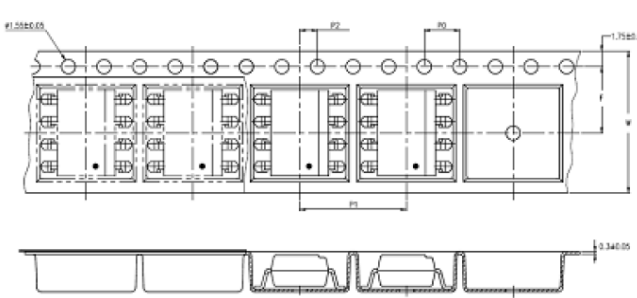
| Description | Symbol | Dimension in mm (inch) |
|--|----------------|------------------------|
| Tape wide | W | 16±0.3 (0.63) |
| Pitch of sprocket holes | P ₀ | 4±0.1 (0.15) |
| Distance of compartment | F | 7.5±0.1 (0.295) |
| | P ₂ | 2±0.1 (0.079) |
| Distance of compartment to compartment | P ₁ | 8±0.1 (0.472) |

3.5 Quantities Per Reel

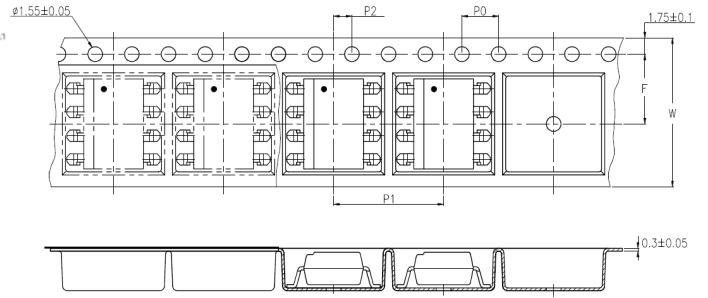
| Package Type | TP |
|------------------|------|
| Quantities (pcs) | 2000 |

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3.6 LTV-827S-TA



3.7 LTV-827S-TA1



| Description | Symbol | Dimension in mm (inch) |
|--|--------|------------------------|
| Tape wide | W | 16 ± 0.3 (0.63) |
| Pitch of sprocket holes | P_0 | 4 ± 0.1 (0.15) |
| Distance of compartment | F | 7.5 ± 0.1 (0.295) |
| | P_2 | 2 ± 0.1 (0.079) |
| Distance of compartment to compartment | P_1 | 12 ± 0.1 (0.472) |

3.8 Quantities Per Reel

| Package Type | TA/TA1 |
|------------------|--------|
| Quantities (pcs) | 1000 |

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4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings at Ta=25°C

| | Parameter | Symbol | Rating | Unit |
|--------|--|--------------------|------------|-----------|
| Input | Forward Current | I_F | 50 | mA |
| | Reverse Voltage | V_R | 6 | V |
| | Power Dissipation | P | 70 | mW |
| | Peak Forward Current (100 μ s pulse, 100Hz frequency) | IFP | 1 | A |
| | Thermal Resistance Junction-Ambient | Rth _{J-A} | 325 | °C/W |
| | Thermal Resistance Junction-Case | Rth _{J-C} | 200 | °C/W |
| Output | Collector - Emitter Voltage | V_{CEO} | 35 | V |
| | Emitter - Collector Voltage | V_{ECO} | 6 | V |
| | Collector Current | I_C | 50 | mA |
| | Collector Power Dissipation | P_C | 150 | mW |
| | Total Power Dissipation | P_{tot} | 200 | mW |
| 1. | Isolation Voltage | V_{iso} | 5000 | V_{rms} |
| | Operating Temperature (LTV-827/847) | T_{opr} | -30 ~ +100 | °C |
| | Operating Temperature (LTV-817) | T_{opr} | -55 ~ +110 | °C |
| | Storage Temperature | T_{stg} | -55 ~ +125 | °C |
| | Soldering Temperature | T_{sol} | 260 | °C |

1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

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4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

| Parameter | | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|--------------------------|--------------------------------------|---------------|--------------------|--------------------|------|---------------|--|
| Input | Forward Voltage | V_F | — | 1.2 | 1.4 | V | $I_F=20\text{mA}$ |
| | Reverse Current | I_R | — | — | 10 | μA | $V_R=4\text{V}$ |
| | Terminal Capacitance | C_t | — | 30 | 250 | pF | $V=0, f=1\text{KHz}$ |
| Output | Collector Dark Current | I_{CEO} | — | — | 100 | nA | $V_{CE}=20\text{V}, I_F=0$ |
| | Collector-Emitter Breakdown Voltage | BV_{CEO} | 35 | — | — | V | $I_C=0.1\text{mA}, I_F=0$ |
| | Emitter-Collector Breakdown Voltage | BV_{ECO} | 6 | — | — | V | $I_E=10\mu\text{A}, I_F=0$ |
| TRANSFER CHARACTERISTICS | Collector Current | I_C | 2.5 | — | 30 | mA | $I_F=5\text{mA}, V_{CE}=5\text{V}$ |
| | 1. Current Transfer Ratio | CTR | 50 | — | 600 | % | |
| | Collector-Emitter Saturation Voltage | $V_{CE(sat)}$ | — | 0.1 | 0.2 | V | $I_F=20\text{mA}, I_C=1\text{mA}$ |
| | Isolation Resistance | R_{iso} | 5×10^{10} | 1×10^{11} | — | Ω | DC500V, 40 ~ 60% R.H. |
| | Floating Capacitance | C_f | — | 0.6 | 1 | pF | $V=0, f=1\text{MHz}$ |
| | Cut-off Frequency | f_c | — | 80 | — | kHz | $V_{CE}=5\text{V}, I_C=2\text{mA}$ $R_L=100\Omega, -3\text{dB}$ |
| | Response Time (Rise) | t_r | — | 4 | 18 | μs | $V_{CE}=2\text{V}, I_C=2\text{mA}$ $R_L=100\Omega,$ |
| | Response Time (Fall) | t_f | — | 3 | 18 | μs | |

$$1. \text{CTR} = \frac{I_C}{I_F} \times 100\%$$

**Photocoupler
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5. RANK TABLE OF CURRENT TRANSFER RATIO

| | CTR Rank | Min | Max | Condition |
|---------|-----------------------|-----|-----|---------------------------------------|
| LTV-817 | L | 50 | 100 | $I_F=5mA, V_{CE}=5V, T_a=25^{\circ}C$ |
| | A | 80 | 160 | |
| | B | 130 | 260 | |
| | C | 200 | 400 | |
| | D | 300 | 600 | |
| | L or A or B or C or D | 50 | 600 | |
| LTV-827 | No Bin | 50 | 600 | |
| | B | 130 | 260 | |
| | C | 200 | 400 | |
| | D | 300 | 600 | |
| | BC | 130 | 400 | |
| | CD | 200 | 600 | |
| LTV-847 | No Bin | 50 | 600 | |
| | BC | 130 | 400 | |
| | CD | 200 | 600 | |

Photocoupler LTV-8x7 Series

6. CHARACTERISTICS CURVES

Fig.1 Forward Current vs. Ambient Temperature

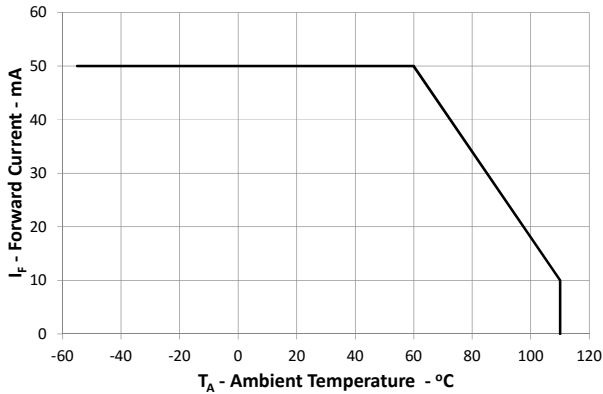


Fig.2 Collector Power Dissipation vs. Ambient Temperature

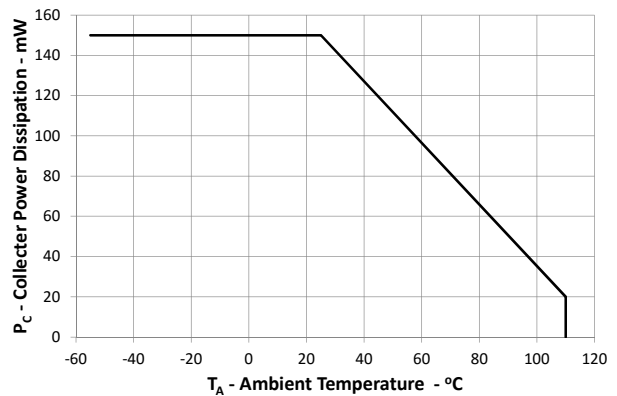


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

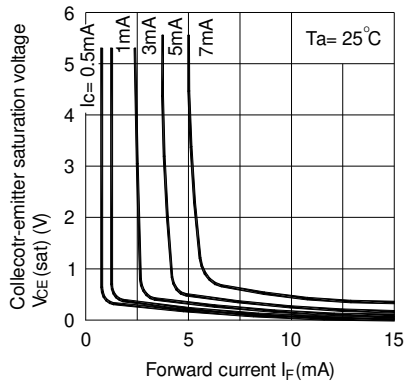


Fig.4 Forward Current vs. Forward Voltage

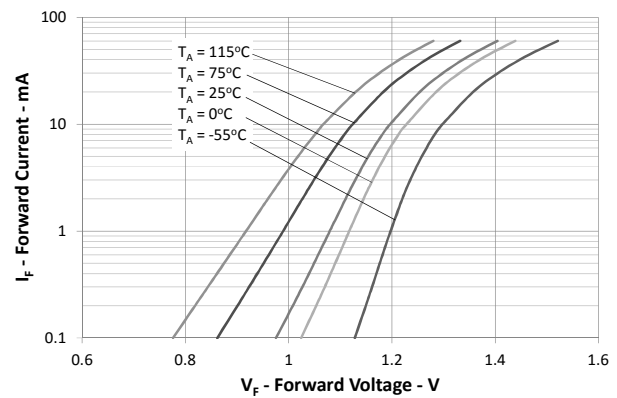


Fig.5 Current Transfer Ratio vs. Forward Current

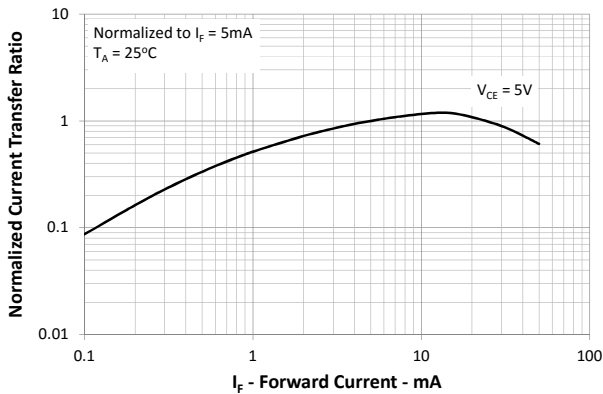
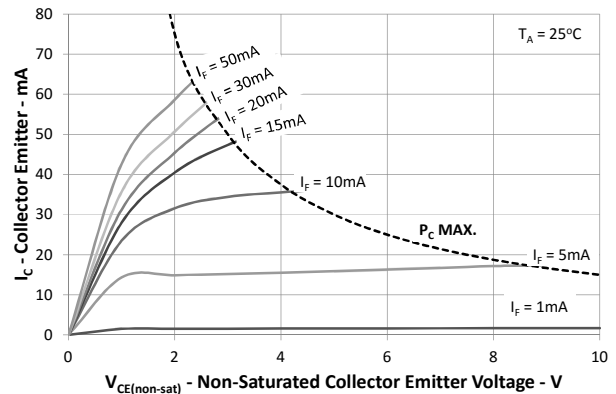


Fig.6 Collector Current vs. Collector-emitter Voltage



Photocoupler LTV-8x7 Series

Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

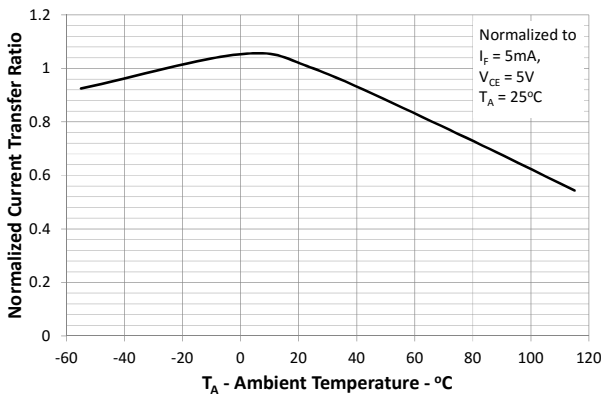


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

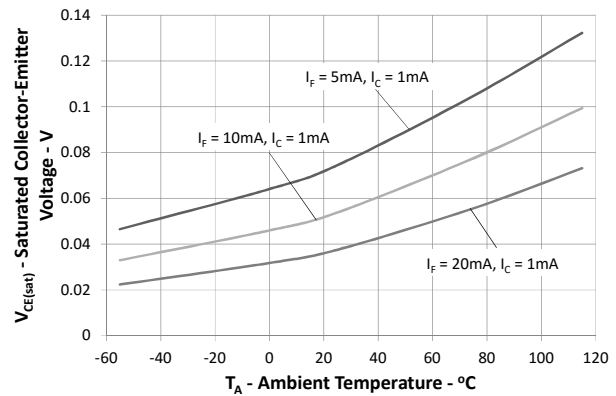


Fig.9 Collector Dark Current vs. Ambient Temperature

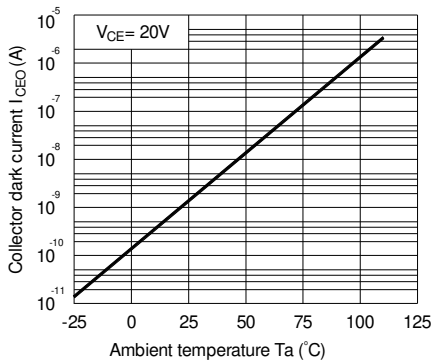


Fig.10 Response Time vs. Load Resistance

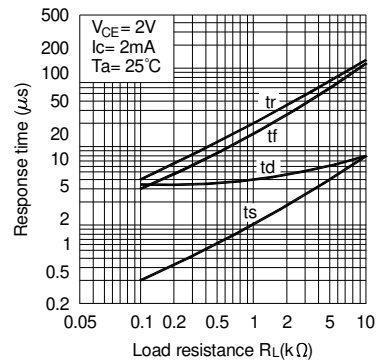
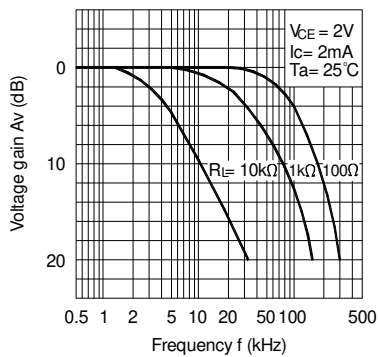
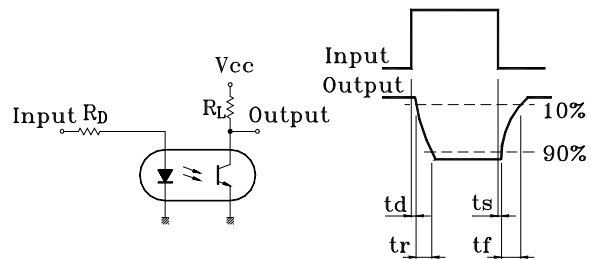


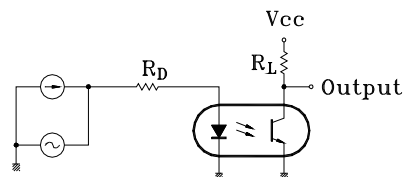
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



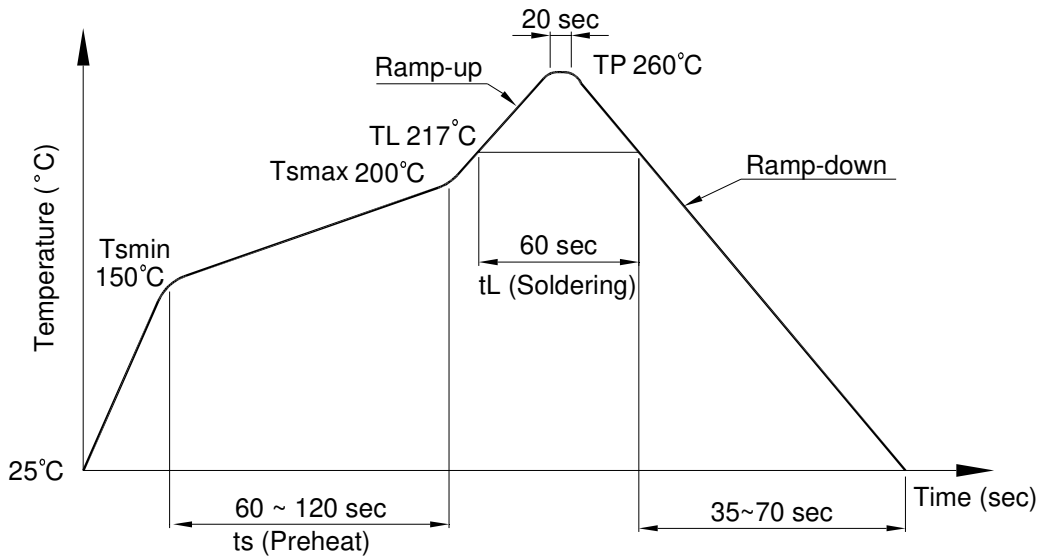
Photocoupler LTV-8x7 Series

7. TEMPERATURE PROFILE OF SOLDERING

7.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

| Profile item | Conditions |
|----------------------------------|----------------|
| Preheat | |
| - Temperature Min (T_{Smin}) | 150°C |
| - Temperature Max (T_{Smax}) | 200°C |
| - Time (min to max) (ts) | 90±30 sec |
| Soldering zone | |
| - Temperature (T_L) | 217°C |
| - Time (t_L) | 60 sec |
| Peak Temperature (T_P) | 260°C |
| Ramp-up rate | 3°C / sec max. |
| Ramp-down rate | 3~6°C / sec |



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7.2 Wave soldering (JEDEC22A111 compliant)

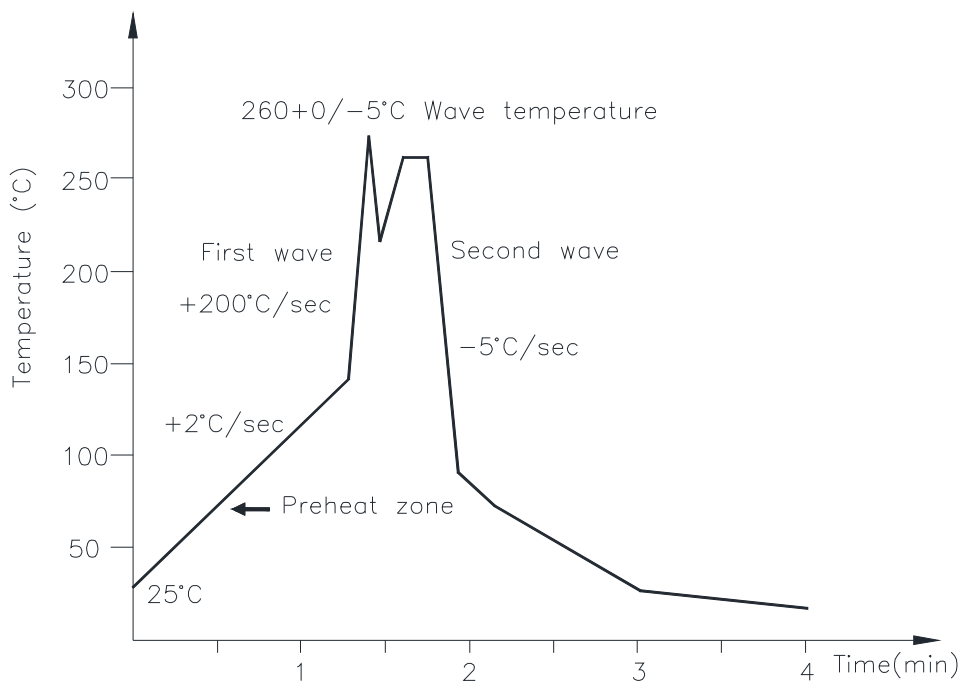
One time soldering is recommended within the condition of temperature.

Temperature: $260 \pm 0/-5^\circ\text{C}$

Time: 10 sec.

Preheat temperature: 25 to 140°C

Preheat time: 30 to 80 sec.



7.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

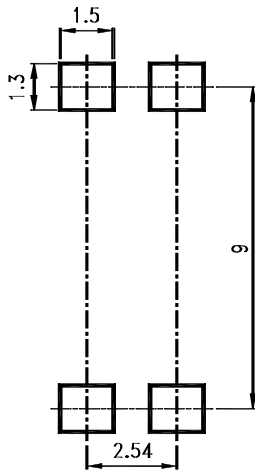
Temperature: $380 \pm 0/-5^\circ\text{C}$

Time: 3 sec max.

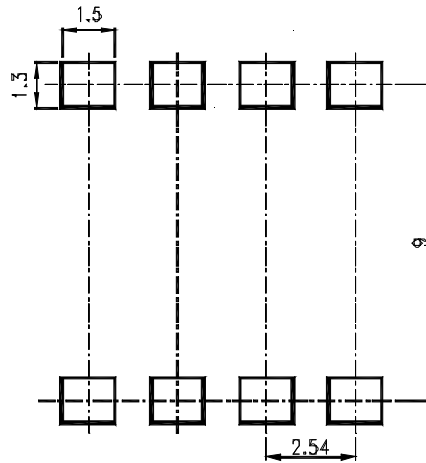
**Photocoupler
LTV-8x7 Series**

8. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

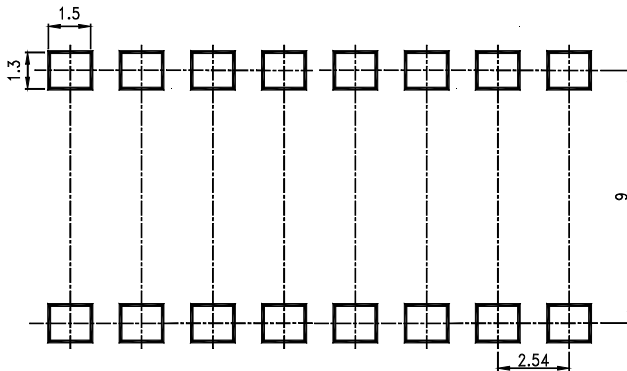
8.1 4 PIN



8.2 8 PIN



8.3 16 PIN



Note :

Dimensions in millimeters.

**Photocoupler
LTV-8x7 Series**

9. Naming rule

LTV-8X7(1)-(2)-(3)-G

DEVICE PART NUMBER

- (1) No suffix = Dual-in-Line package
M = Wide lead spacing package
S = Surface mounting package
- (2) TAPING TYPE(TA,TA1,TP or none)
LTV-817 and LTV-827 have tape and reel solution.
Please refer to orientation of taping on Page P5-P7
- (3) CTR RANK (A,B or none)
Please refer to the CTR table on Page P10
- (4) Halogen free option

Example : LTV-817S-TA1-A-G

LTV8X7(1)(2)(3)-V-G

DEVICE PART NUMBER

- (1) No suffix = Dual-in-Line package
M = Wide lead spacing package
S = Surface mounting package
- (2) TAPING TYPE(TA,TA1,TP or none)
LTV-817 and LTV-827 have tape and reel solution
Please refer to orientation of taping on Page P5-P7
- (3) CTR RANK (A,B or none)
Please refer to the CTR table on Page P10
- (4) VDE order option
- (5) Halogen free option

Example : LTV817STA1A-V-G

Photocoupler LTV-8x7 Series

10. Notes:

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.
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